12V P-Channel Trench Power MOSFET

General Description

The SJA12P130 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as -2.5V. This device is suitable for use as a wide variety of applications.

Features

- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

Application

- PWM Applications
- Load Switch
- Power Management

Key Performance Parametes

| Parameter | Value | Unit |
|-------------------------|-------|------|
| BV _{DSS_TYP} | -18 | V |
| R _{DS(ON)_TYP} | 13.3 | mΩ |
| I _D | -9.1 | A |
| Q _G | 20 | nC |



Package Marking and Ordering Information

| Device/Ordering Code | Marking | Package | Packing | Reel Size | Tape width | Quantity |
|----------------------|---------|-----------|---------|-----------|------------|----------|
| SJA12P130 | 1209 | SOT-23-3L | Tape | \ | / | 3000 Pcs |

Table 1. Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

| Symbol | Parameter | Limit | Unit |
|---|---|------------|------|
| V _{DS} | Drain-Source Voltage (V _{GS} =0V) | -12 | V |
| V _G s | Gate-Source Voltage (V _{DS} =0V) ±12 \ | | V |
| 1- | Drain Current-Continuous(T _A =25°C) | -9.1 | А |
| I _D Drain Current-Continuous(T _A =100°C) | | -5.8 | А |
| I _{DM} (pluse) | Drain Current-Continuous@ Current-Pulsed (Note 1) | -36.4 | А |
| D- | Maximum Power Dissipation(T _A =25°ℂ) | 2 | W |
| P _D Maximum Power Dissipation(T _A =100°C) | | 0.8 | W |
| Eas | Avalanche energy (Note 2) | 20 | mJ |
| TJ, TSTG | Operating Junction and Storage Temperature Range | -55 To 150 | c |

Table 2. Thermal Characteristic

| Symbol | Parameter | | Max | Unit |
|---|-----------|--|-----|------|
| R _{θJA} Thermal Resistance, Junction-to- Ambient | | | 63 | °C/W |



12V P-Channel Trench Power MOSFET

Table 3. Electrical Characteristics (T_J=25℃ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|-----------------------------------|---|------|------|------|------|
| On/Off States | • | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V I _D =-250μA | -12 | -18 | | V |
| | 7 0 1 1/1 1 2 1 0 1 | V _{DS} =-12V, V _{GS} =0V T _J =25℃ | | | -1 | μΑ |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =-12V, V _{GS} =0V T _J =125℃ | | | -100 | μΑ |
| Igss | Gate-Body Leakage Current | V _{GS} =±12V, V _{DS} =0V | | | ±100 | nA |
| $V_{GS(th)}$ | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =-250μA | -0.5 | | -1 | V |
| G FS | Forward Transconductance | V _{DS} =-5V, I _D =-10A | | 16.6 | | S |
| R _{DS(ON)} | Drain-Source On-State Resistance | V _{GS} =-4.5V, I _D =-5A T _J =25°C | | 13.3 | 17.3 | mΩ |
| R _{DS(ON)} | Drain-Source On-State Resistance | V _{GS} =-2.5V, I _D =-4A T _J =25°C | | 18.4 | 24.5 | mΩ |
| Dynamic Chara | octeristics | | | • | | |
| Ciss | Input Capacitance | | | 1470 | | pF |
| Coss | Output Capacitance | V _{DS} =-10V,V _{GS} =0V, f=1.0MHz | | 314 | | pF |
| Crss | Reverse Transfer Capacitance | | | 292 | | pF |
| Rg | Gate resistance | V _{GS} =0V, V _{DS} =0V, f=1.0MHz | | 25 | | Ω |
| Switching Para | meters | | | • | | |
| t _{d(on)} | Turn-on Delay Time | | | 14.4 | | nS |
| t _r | Turn-on Rise Time | V _{GS} =-10V, V _{DS} =-6V, | | 5.5 | | nS |
| $t_{d(off)}$ | Turn-Off Delay Time | $R_L=2\Omega$, $R_{GEN}=3\Omega$ | | 59.4 | | nS |
| t _f | Turn-Off Fall Time | | | 21.6 | | nS |
| Qg | Total Gate Charge | | | 20 | | nC |
| Q _{gs} | Gate-Source Charge | V _{GS} =-4.5V, V _{DS} =-6V, I _D =-5A | | 5 | | nC |
| Q_gd | Gate-Drain Charge | | | 6 | | nC |
| Source-Drain D | liode Characteristics | | • | • | | |
| I _{SD} | Source-Drain Current (Body Diode) | | | | -9.1 | А |
| V _{SD} | Forward on Voltage (Note 3) | V _{GS} =0V, I _S =-5A | | | -1.2 | V |
| t _{rr} | Reverse Recovery Time | I _F =-5A, dI/dt=-100A/μs | | 31.2 | | ns |
| Qrr | Reverse Recovery Charge | I _F =-5A, dI/dt=-100A/μs | | 10.9 | | nC |

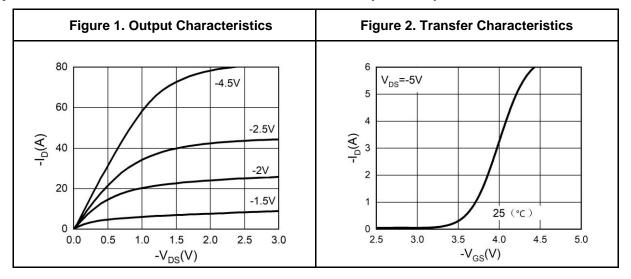
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

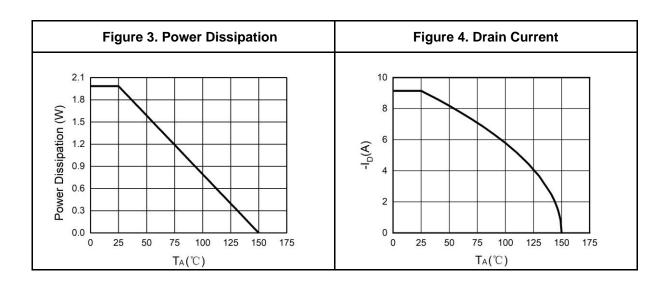
Notes 2.E_{AS} condition: $T_J=25^{\circ}C$, $V_{DD}=-20V$, $V_{G}=-10V$, $Rg=25\Omega$, L=0.5mH.

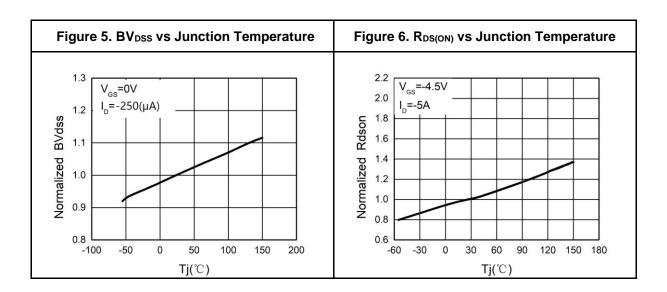
Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



Typical Electrical And Thermal Characteristics (Curves)

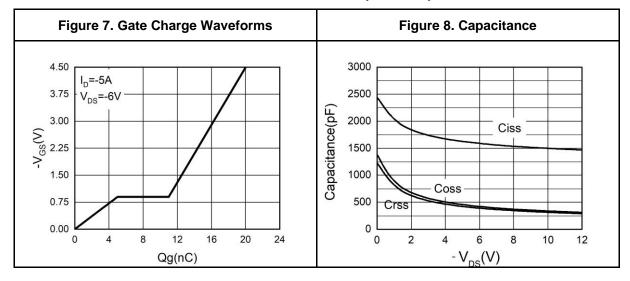


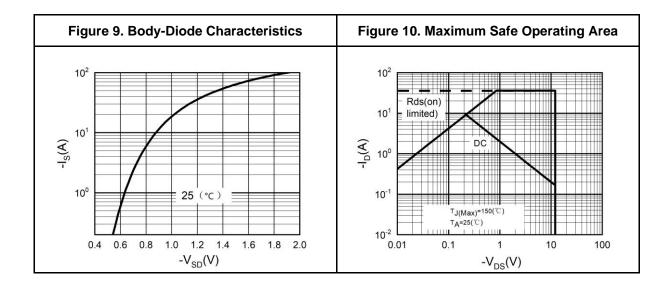






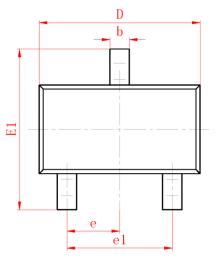
Typical Electrical And Thermal Characteristics (Curves)

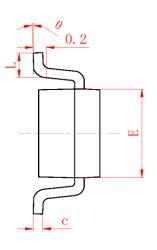




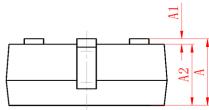


SOT-23-3L Package Information





| | MILLI | METER |
|--------|-------|--------|
| SYMBOL | MIN | MAX |
| A | 1.050 | 1. 250 |
| A1 | 0.000 | 0. 100 |
| A2 | 1.050 | 1. 150 |
| b | 0.250 | 0. 450 |
| с | 0.100 | 0.200 |
| D | 2.820 | 3.020 |
| E | 1.500 | 1. 700 |
| E1 | 2.650 | 2. 950 |
| e | 0.950 | (BSC) |
| e1 | 1.800 | 2.000 |
| L | 0.300 | 0.500 |
| θ | 0° | 8° |



| Compleal | Dimensions I | n Millimeters | |
|----------|--------------|---------------|--|
| Symbol | Min. | Max. | |
| А | 1.050 | 1.250 | |
| A1 | 0.000 | 0.100 | |
| A2 | 1.050 | 1.150 | |
| b | 0.250 | 0.450 | |
| С | 0.100 | 0.200 | |
| D | 2.820 | 3.020 | |
| Е | 1.500 | 1.700 | |
| E1 | 2.650 | 2.950 | |
| е | 0.950(BSC) | | |
| e 1 | 1.800 | 2.000 | |
| L | 0.300 | 0.500 | |
| θ | 0° | 8° | |

12V P-Channel Trench Power MOSFET

Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

The performances and characteristics of this product in the independent testing state are displayed in this document. Wuxi Shangjia Semiconductor can't guarantee of the performances and characteristics of this described product that mounted in the customer's products or equipments as same as that in the independent testing state. So the customer should evaluate and test devices mounted in the customer's products or equipments.

Wuxi Shangjia Semiconductor reserves the right to improve the designs, functions and reliability of this product and modify any and all information described in this document without notice customer, apart from that when an notice agreement is signed between customer and Wuxi Shangjia Semiconductor.

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Wuxi Shangjia Semiconductor hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.